

NPN Silicon RF Transistor

- Low noise amplifier designed for low voltage applications, ideal for 1.2 V or 1.8 V supply voltage. Supports 2.9 V V_{cc} with enough external collector resistance.
- High gain and low noise at high frequencies due to high transit frequency $f_T = 45 \text{ GHz}$
- Finds usage e.g. in cordless phones and satellite receivers
- Pb-free (RoHS compliant) standard package with visible leads
- Qualified according AEC Q101



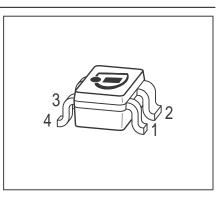
ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFP520	APs	1=B	2=E	3=C	4=E	-	-	SOT343

Maximum Ratings at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CEO}		V
		2.5	
$T_{A} = -55 \ ^{\circ}\mathrm{C}$		2.4	
Collector-emitter voltage	V _{CES}	10	
Collector-base voltage	V _{CBO}	10	
Emitter-base voltage	V _{EBO}	1	
Collector current	I _C	40	mA
Base current	/ _B	4	
Total power dissipation ¹⁾	P _{tot}	100	mW
<i>T</i> _S ≤ 105 °C			
Junction temperature	TJ	150	°C
Storage temperature	T _{Stg}	-55 150	

 $^{1}T_{S}$ is measured on the emitter lead at the soldering point to pcb





Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}	≤ 450	K/W

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

Parameter	Symbol		Values		
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V _{(BR)CEO}	2.5	3	3.5	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					
Collector-emitter cutoff current	ICES				nA
$V_{CE} = 2 V, V_{BE} = 0$		-	1	30	
$V_{CE} = 10 \text{ V}, V_{BE} = 0$		-	-	1000	
Collector-base cutoff current	ICBO	-	-	30	
$V_{\rm CB} = 2 \text{V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	100	3000	
$V_{\rm EB} = 0.5 \text{V}, \ I_{\rm C} = 0$					
DC current gain	h _{FE}	70	110	170	-
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 2 V, pulse measured					

¹For calculation of $R_{\rm thJA}$ please refer to Application Note AN077 Thermal Resistance



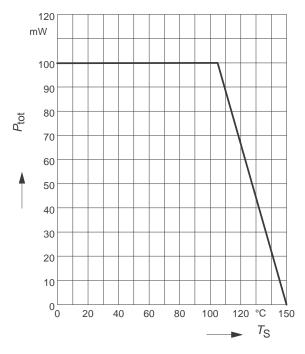
Parameter	Symbol	Values			Unit	
		min.	typ.	max.		
AC Characteristics (verified by random samplin	g)	1				
Transition frequency	f _T	32	45	-	GHz	
$I_{\rm C} = 30 \text{ mA}, V_{\rm CE} = 2 \text{ V}, f = 2 \text{ GHz}$						
Collector-base capacitance	C _{cb}	-	0.07	0.13	pF	
$V_{CB} = 2 V, f = 1 MHz, V_{BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.3	-		
$V_{CE} = 2 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	0.33	-		
$V_{\rm EB} = 0.5 \text{V}, f = 1 \text{MHz}, V_{\rm CB} = 0 ,$						
collector grounded						
Minimum noise figure	NF _{min}	-	0.95	-	dB	
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 2 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
f = 1.8 GHz						
Power gain, maximum stable ¹⁾	G _{ms}	-	24	-	dB	
$I_{\rm C} = 20 \text{ mA}, V_{\rm CE} = 2 \text{ V}, Z_{\rm S} = Z_{\rm Sopt}, Z_{\rm L} = Z_{\rm Lopt},$						
f = 1.8 GHz						
Insertion power gain	S ₂₁ ²	-	21.5	-]	
V _{CE} = 2 V, <i>I</i> _C = 20 mA, <i>f</i> = 1.8 GHz,						
$Z_{\rm S} = Z_{\rm L} = 50 \ \Omega$						
Third order intercept point at output	IP ₃				dBm	
$V_{\rm CE} = 2 \text{ V}, I_{\rm C} = 20 \text{ mA}, f = 1.8 \text{ GHz},$						
$Z_{\rm S} = Z_{\rm Sopt}, Z_{\rm L} = Z_{\rm Lopt}$		-	25	-		
$V_{CE} = 2 \text{ V}, I_{C} = 7 \text{ mA}, f = 1.8 \text{ GHz},$						
$Z_{\rm S} = Z_{\rm Sopt,} Z_{\rm L} = Z_{\rm Lopt}$		-	17	-		
1dB Compression point at output	P _{-1dB}				1	
$V_{\rm C} = 20 \text{ mA}, V_{\rm CE} = 2 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$						
$Z_{\rm L} = Z_{\rm Lopt}, f = 1.8 \rm GHz$		-	12	-		
$I_{\rm C} = 7 \text{ mA}, V_{\rm CE} = 2 \text{ V}, Z_{\rm S} = Z_{\rm Sopt},$						
$Z_{\rm L} = Z_{\rm Lopt}, f = 1.8 \text{GHz}$		-	5	-		

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

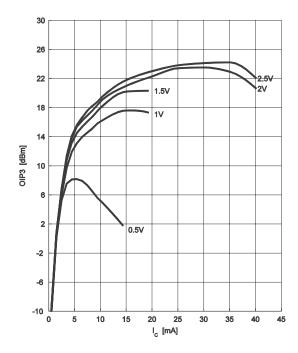
 ${}^{1}G_{\rm ms} = |S_{21} / S_{12}|$



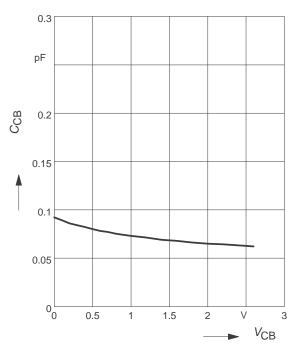
Total power dissipation $P_{tot} = f(T_S)$



Third order Intercept Point $IP_3 = f(I_C)$ (Output, $Z_S = Z_L = 50 \Omega$) V_{CE} = parameter, f = 900 MHz



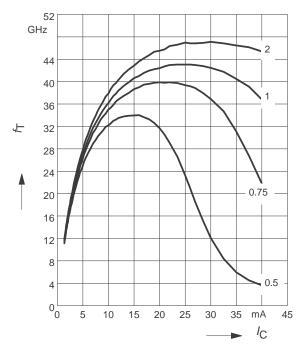
Collector-base capacitance $C_{cb}=f(V_{CB})$ f = 1MHz



Transition frequency $f_{\rm T} = f(I_{\rm C})$

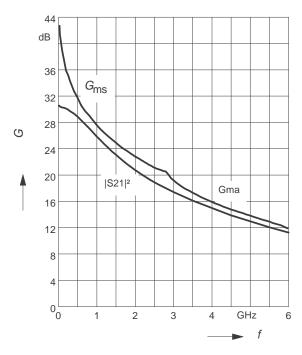
f = 2 GHz



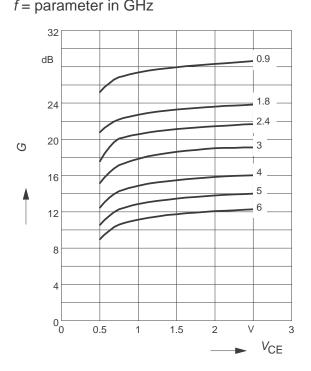




Power gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$ $V_{CE} = 2 \text{ V}$, $I_C = 20 \text{ mA}$



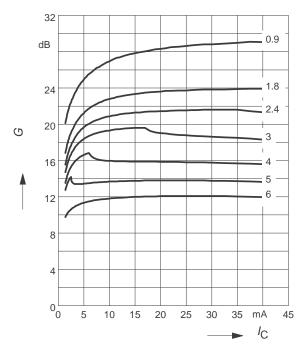
Power gain
$$G_{ma}$$
, $G_{ms} = f(V_{CE})$
 $I_{C} = 20 \text{ mA}$



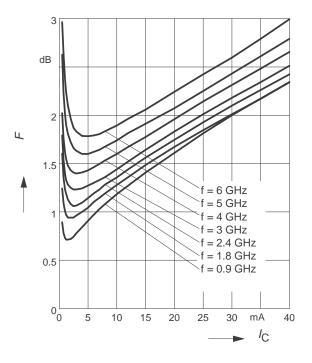
Power gain G_{ma} , $G_{ms} = f(I_C)$

 $V_{CE} = 2V$

f = parameter in GHz

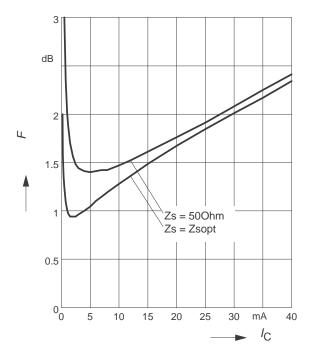


Minimum noise figure $NF_{min} = f(I_C)$ $V_{CE} = 2 \text{ V}, Z_S = Z_{Sopt}$

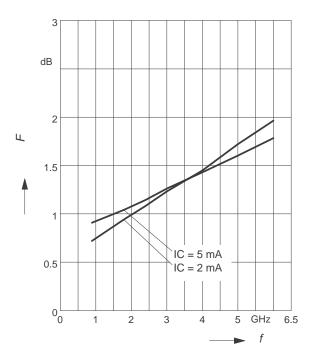




Noise figure $F = f(I_C)$ $V_{CE} = 2 \text{ V}, f = 1.8 \text{ GHz}$

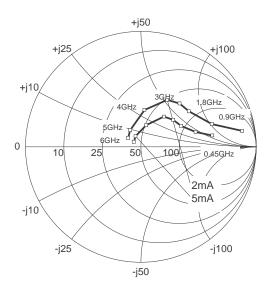


Minimum noise figure $NF_{min} = f(f)$ $V_{CE} = 2 \text{ V}, Z_{S} = Z_{Sopt}$



Source impedance for min.

noise figure vs. frequency $V_{CE} = 2 \text{ V}, I_{C} = 2 \text{ mA} / 5 \text{ mA}$







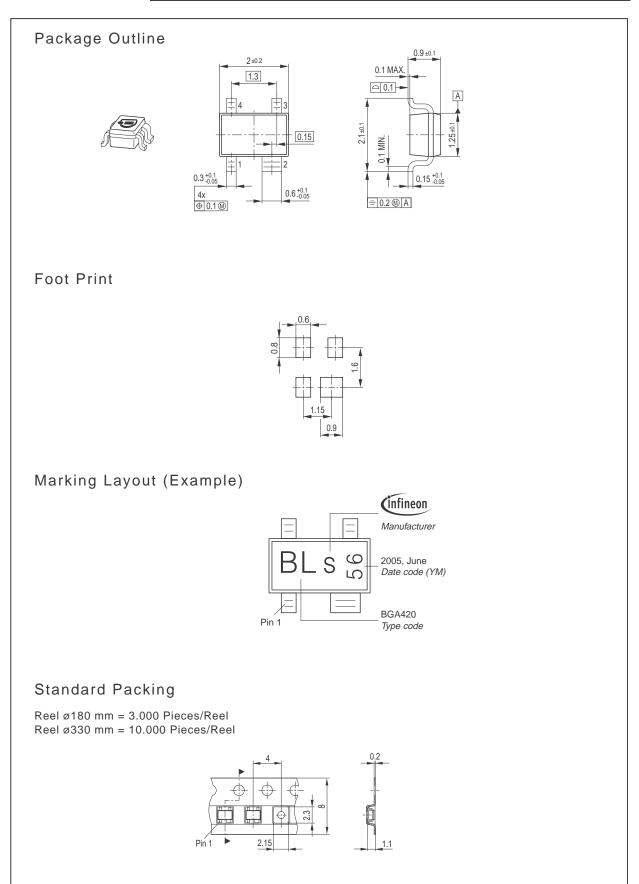
SPICE GP Model

For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website www.infineon.com/rf.models.

Please consult our website and download the latest versions before actually starting your design. You find the BFP520 SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device. The model parameters have been extracted and verified up to 10 GHz using typical devices. The BFP520 SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.



2010-08-16





Datasheet Revision History: 16 August 2010

This datasheet replaces the revision from 30 March 2007 and 28 June 2010. The product itself has not been changed and the device characteristics remain unchanged. Only the product description and information available in the datasheet has been expanded and updated.

Previous	Previous Revisions: 30 March 2007 and 28 June 2010					
Page	Subject (changes since last revision)					
1	Feature list updated					
2	Typical values for leakage currents included, values for maximum leakage					
	currents reduced					
4	OIP3 characteristic added					
7	SPICE model parameters removed from the datasheet, link to the respective					
	internet site added					



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